

DF3D36FU

1. Applications

- ESD Protection

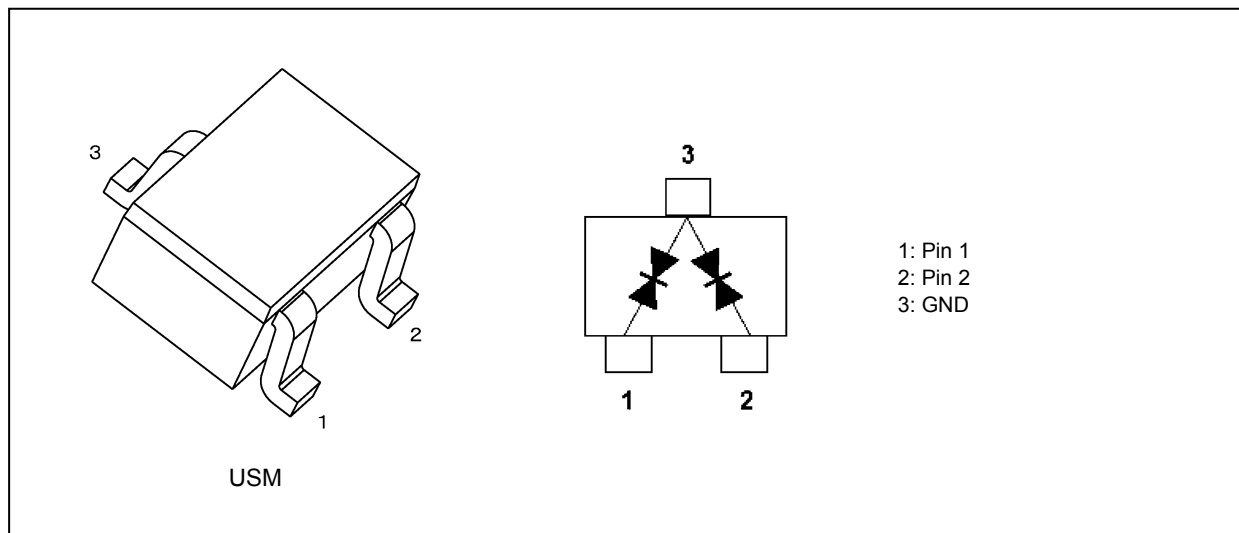
Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

2. Features

- (1) AEC-Q101 qualified (Note 1)

Note 1: For detail information, please contact to our sales.

3. Packaging and Internal Circuit



Start of commercial production

2016-03

4. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25^\circ\text{C}$)

Characteristics	Symbol	Note	Rating	Unit
Electrostatic discharge voltage (IEC61000-4-2)(Contact)	V_{ESD}	(Note 1)	± 20	kV
Electrostatic discharge voltage (IEC61000-4-2)(Air)				
Electrostatic discharge voltage (ISO10605)(Contact)	V_{ESD}	(Note 2)	± 20	kV
Electrostatic discharge voltage (ISO10605)(Air)				
Peak pulse power ($t_p = 8/20 \mu\text{s}$)	P_{PK}		150	W
Peak pulse current ($t_p = 8/20 \mu\text{s}$)	I_{PP}	(Note 3)	2.5	A
Junction temperature	T_j		150	$^\circ\text{C}$
Storage temperature	T_{stg}		-55 to 150	$^\circ\text{C}$

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: According to IEC61000-4-2.

Note 2: According to ISO10605. (@ $C = 330 \text{ pF}$, $R = 2 \text{ k}\Omega$)

Note 3: According to IEC61000-4-5.

5. Electrical Characteristics (Unless otherwise specified, $T_a = 25^\circ\text{C}$)

V_{RWM} : Working peak reverse voltage
 V_{BR} : Reverse breakdown voltage
 I_{BR} : Reverse breakdown current
 I_R : Reverse current
 V_C : Clamp voltage
 I_{PP} : Peak pulse current
 R_{DYN} : Dynamic resistance

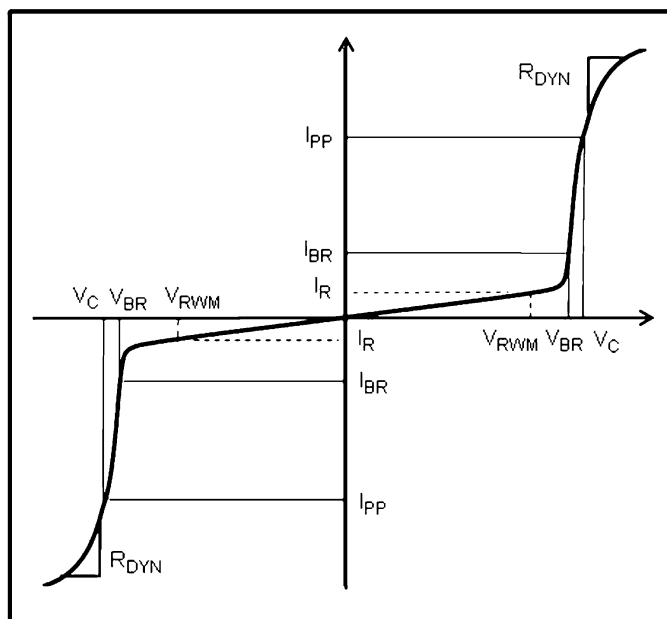


Fig. 5.1 Definitions of Electrical Characteristics

Characteristics	Symbol	Note	Test Condition	Min	Typ.	Max	Unit
Working peak reverse voltage	V_{RWM}		—	—	—	28	V
Reverse breakdown voltage	V_{BR}		$I_{BR} = 1 \text{ mA}$	32	36	40	V
Reverse current	I_R		$V_{RWM} = 28 \text{ V}$	—	—	0.1	μA
Clamp voltage	V_C	(Note 1)	$I_{PP} = 1 \text{ A}$	—	40	—	V
			$I_{PP} = 2.5 \text{ A}$	—	50	60	
Dynamic resistance	R_{DYN}	(Note 2)	—	—	1.5	—	Ω
Total capacitance	C_t	(Note 3)	$V_R = 0 \text{ V}, f = 1 \text{ MHz}$	—	6.5	8	pF

Note 1: Based on IEC61000-4-5 8/20 μs pulse.

Note 2: TLP parameter: $Z_0 = 50 \Omega$, $t_p = 100 \text{ ns}$, $t_r = 300 \text{ ps}$, averaging window: $t_1 = 30 \text{ ns}$ to $t_2 = 60 \text{ ns}$, extraction of dynamic resistance using a least-squares fit of TLP characteristics at I_{PP} between 8 A to 16 A.

Note 3: Guaranteed by design.

6. Marking

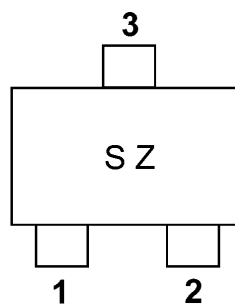


Fig. 6.1 Marking

7. Land Pattern Dimensions (for reference only)

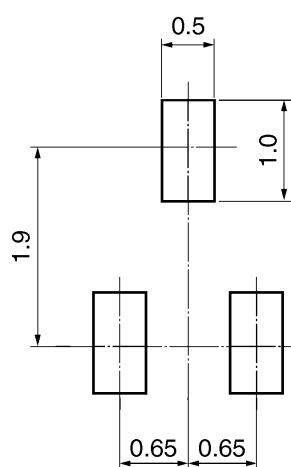


Fig. 7.1 Land Pattern Dimensions (Unit: mm)

8. Characteristics Curves (Note)

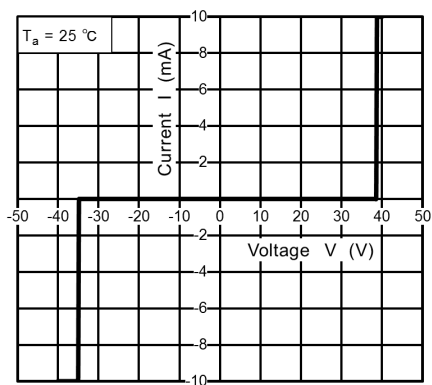


Fig. 8.1 I - V

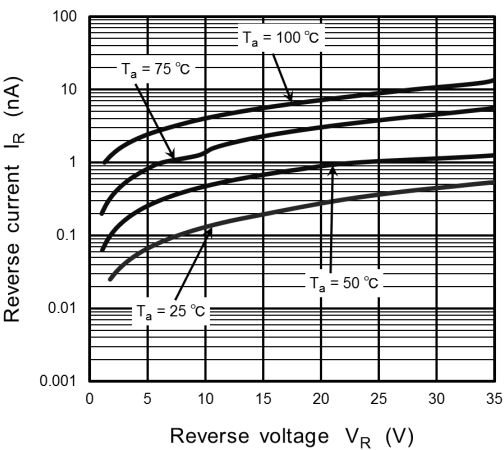


Fig. 8.2 $I_R - V_R$

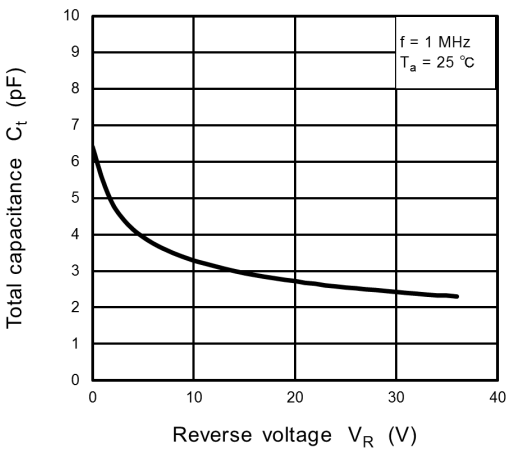


Fig. 8.3 $C_t - V_R$

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

9. Clamp Voltage V_C - Peak Pulse Current (I_{PP}) (Note)

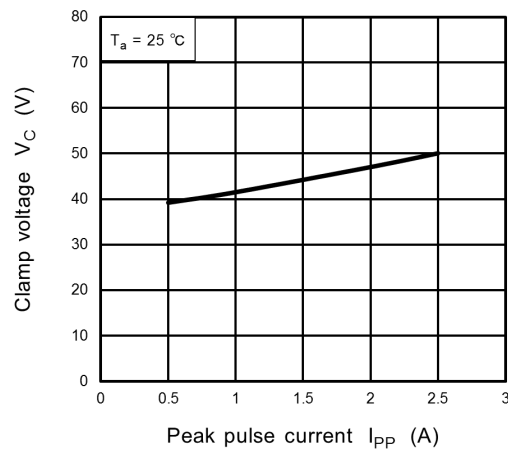


Fig. 9.1 V_C - I_{PP}

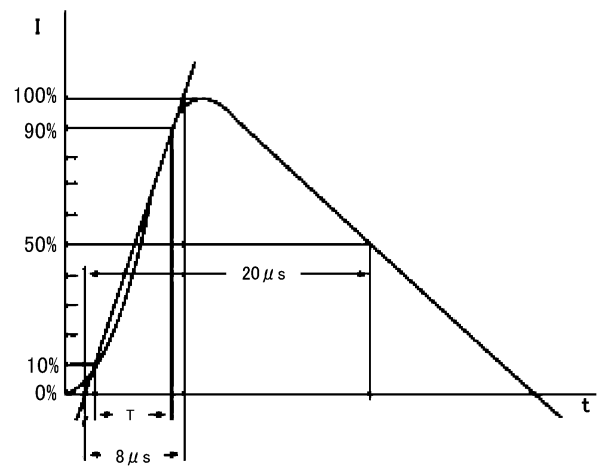


Fig. 9.2 Based on IEC61000-4-5 8/20 μs pulse. (Ed.2)

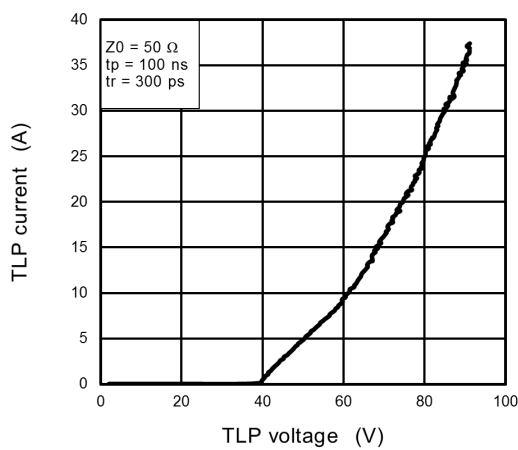


Fig. 9.3 TLP

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

10. ESD Clamp Waveform (Note)

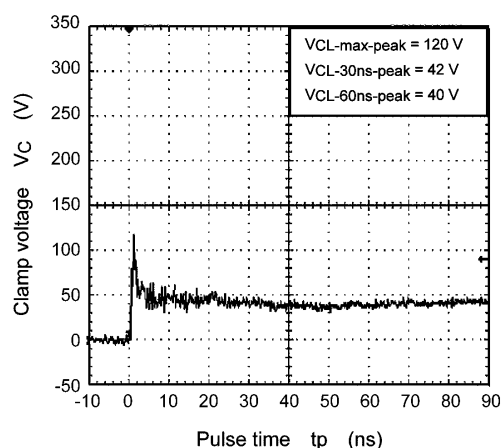


Fig. 10.1 +8 kV (IEC61000-4-2)

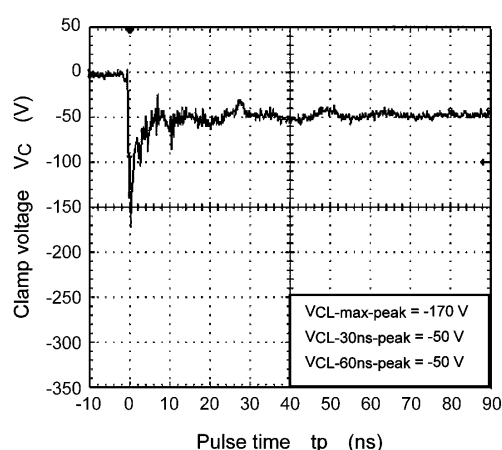


Fig. 10.2 -8 kV (IEC61000-4-2)

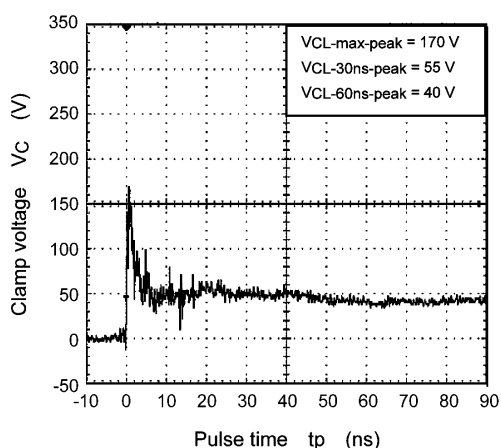


Fig. 10.3 +15 kV (IEC61000-4-2)

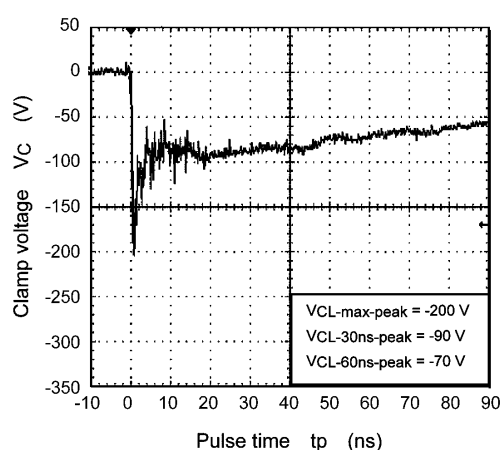


Fig. 10.4 -15 kV (IEC61000-4-2)

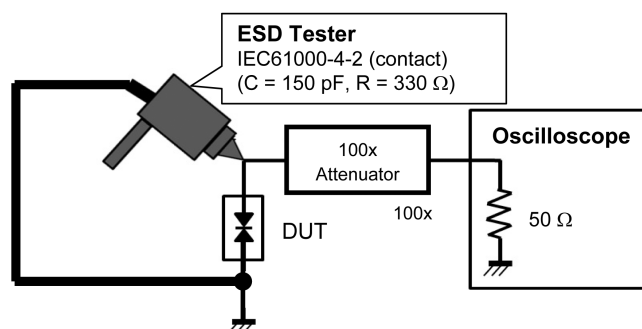


Fig. 10.5 IEC61000-4-2 (Contact)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

11. ESD Clamp Waveform (Note)

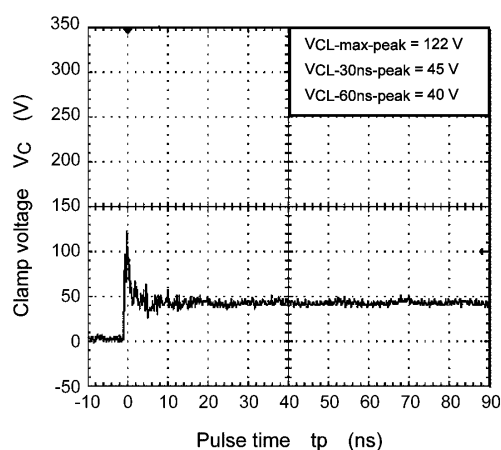


Fig. 11.1 +8 kV (ISO10605)

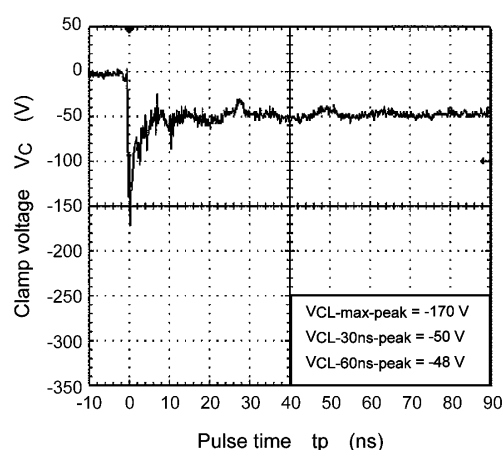


Fig. 11.2 -8 kV (ISO10605)

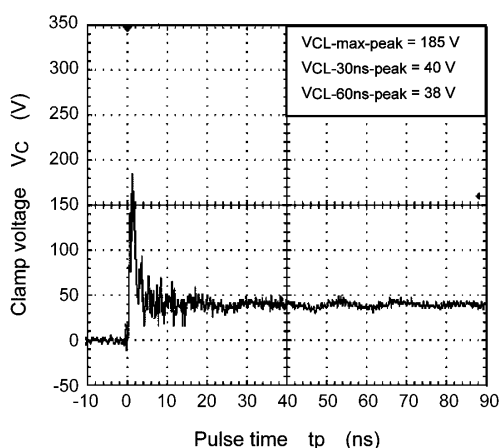


Fig. 11.3 +15 kV (ISO10605)

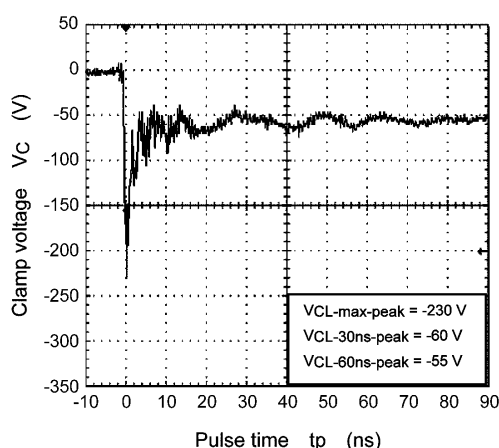


Fig. 11.4 -15 kV (ISO10605)

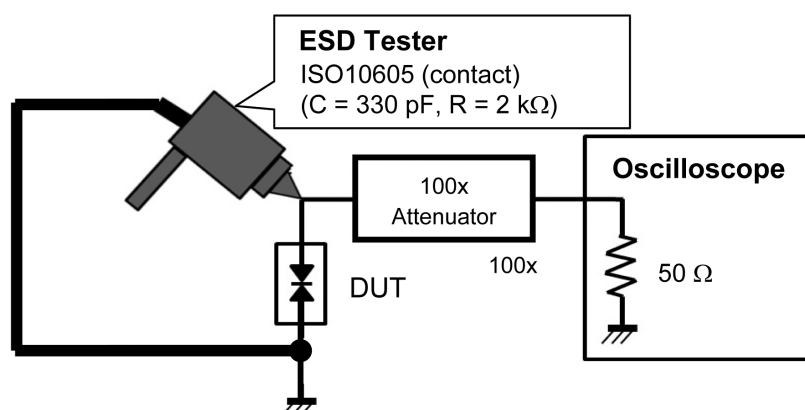
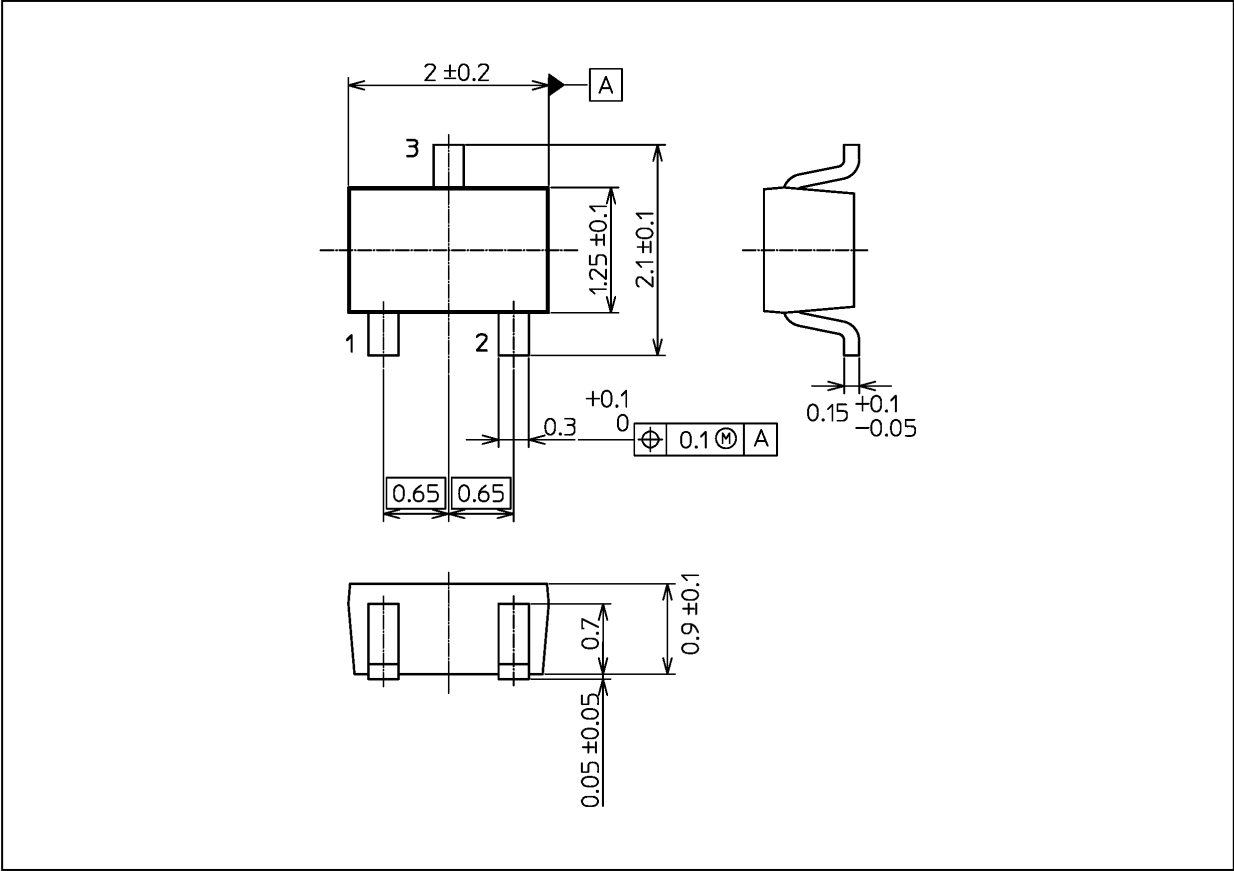


Fig. 11.5 ISO10605-4-2 (contact)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Package Dimensions

Unit: mm



Weight: 6.0 mg (typ.)

Package Name(s)
Nickname: USM

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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
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